

# SN74ALB16244 16-BIT BUFFER/DRIVER WITH 3-STATE OUTPUTS

SCBS647C – AUGUST 1995 – REVISED JULY 1997

- Member of the Texas Instruments *Widebus™* Family
- State-of-the-Art Advanced Low-Voltage BiCMOS (ALB) Technology Design for 3.3-V Operation
- Schottky Diodes on All Inputs to Eliminate Overshoot and Undershoot
- Industry Standard '16244 Pinout
- Distributed V<sub>CC</sub> and GND Pin Configuration Minimizes High-Speed Switching Noise
- Flow-Through Architecture Optimizes PCB Layout
- Package Options Include Plastic 300-mil Shrink Small-Outline (DL) and Thin Shrink Small-Outline (DGG) Packages

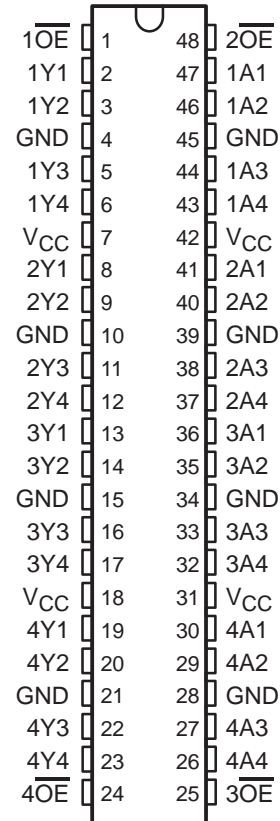
## description

The SN74ALB16244 16-bit buffer and line driver is designed for high-speed, low-voltage (3.3-V) V<sub>CC</sub> operation. This device is intended to replace the conventional driver in any speed-critical path. The small propagation delay is achieved using a unity gain amplifier on the input and feedback resistors from input to output, which allows the output to track the input with a small offset voltage.

The device can be used as four 4-bit buffers, two 8-bit buffers, or one 16-bit buffer. This device provides true outputs and symmetrical active-low output-enable ( $\overline{OE}$ ) inputs.

The SN74ALB16244 is characterized for operation from -40°C to 85°C.

DGG OR DL PACKAGE  
(TOP VIEW)



FUNCTION TABLE  
(each buffer)

| INPUTS          |   | OUTPUT |
|-----------------|---|--------|
| $\overline{OE}$ | A | Y      |
| L               | H | H      |
| L               | L | L      |
| H               | X | Z      |



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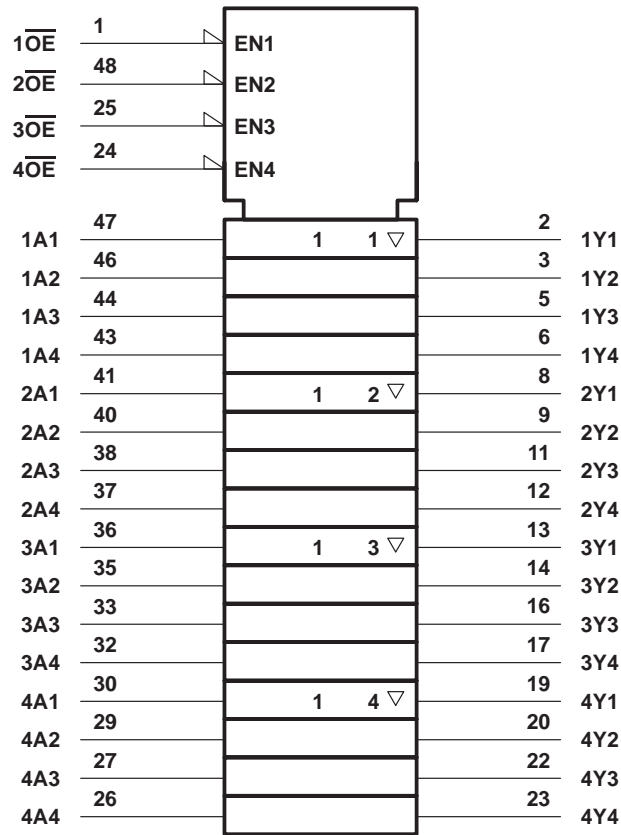
# SN74ALB16244

## 16-BIT BUFFER/DRIVER

### WITH 3-STATE OUTPUTS

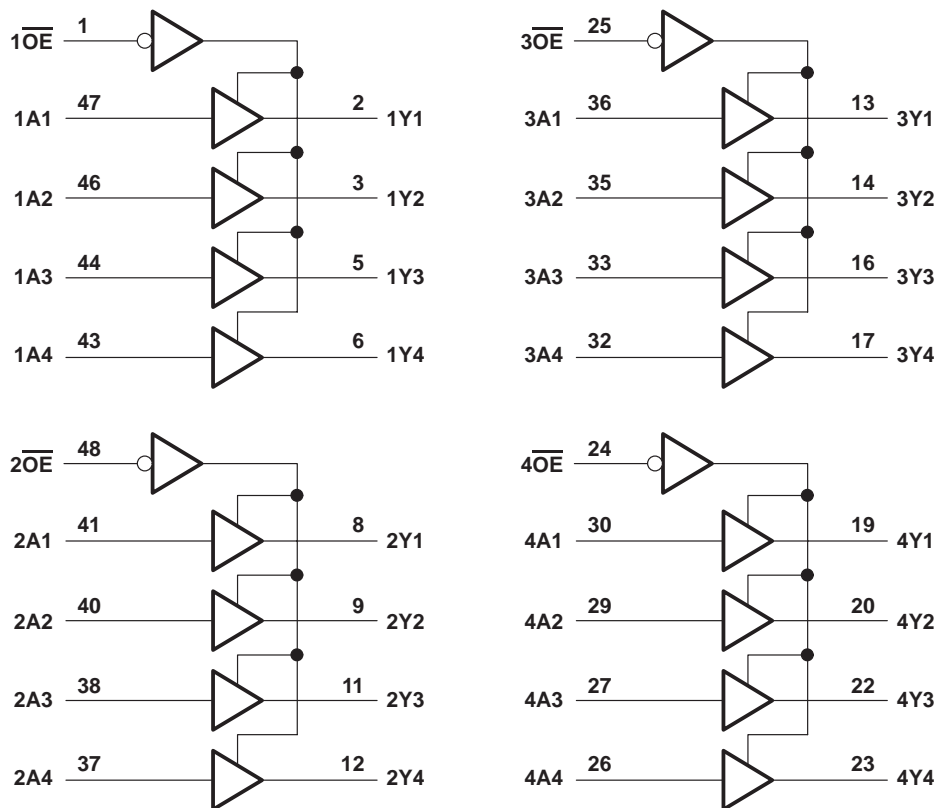
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#### logic symbol†



† This symbol is in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12.

logic diagram (positive logic)



absolute maximum ratings over operating free-air temperature range (unless otherwise noted)†

|                                                                          |                            |
|--------------------------------------------------------------------------|----------------------------|
| Supply voltage range, $V_{CC}$ .....                                     | -0.5 V to 4.6 V            |
| Input voltage range, $V_I$ : Except I/O ports (see Note 1) .....         | -0.5 V to 4.6 V            |
| I/O ports (see Notes 1 and 2) .....                                      | -0.5 V to $V_{CC} + 0.5$ V |
| Output voltage range, $V_O$ (see Notes 1 and 2) .....                    | -0.5 V to $V_{CC} + 0.5$ V |
| Input clamp current, $I_{IK}$ ( $V_I < 0$ ) .....                        | -50 mA                     |
| Output clamp current, $I_{OK}$ ( $V_O < 0$ or $V_O > V_{CC}$ ) .....     | $\pm 50$ mA                |
| Continuous output current, $I_O$ ( $V_O = 0$ to $V_{CC}$ ) .....         | $\pm 50$ mA                |
| Continuous current through each $V_{CC}$ or GND .....                    | $\pm 100$ mA               |
| Package thermal impedance, $\theta_{JA}$ (see Note 3): DGG package ..... | 89°C/W                     |
| DL package .....                                                         | 94°C/W                     |
| Storage temperature range, $T_{stg}$ .....                               | -65°C to 150°C             |

† Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

- NOTES: 1. The input and output negative-voltage ratings may be exceeded if the input and output clamp-current ratings are observed.  
2. This value is limited to 4.6 V maximum.  
3. The package thermal impedance is calculated in accordance with JESD 51.

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**recommended operating conditions**

|                     |                                    | MIN | MAX | UNIT |
|---------------------|------------------------------------|-----|-----|------|
| $V_{CC}$            | Supply voltage                     | 3   | 3.6 | V    |
| $I_{OH}^{\dagger}$  | High-level output current          |     | -25 | mA   |
| $I_{OL}^{\dagger}$  | Low-level output current           |     | 25  | mA   |
| $\Delta t/\Delta v$ | Input transition rise or fall rate |     | 5   | ns/V |
| $T_A$               | Operating free-air temperature     | -40 | 85  | °C   |

<sup>†</sup> Refer to Figures 1 and 2 for typical I/O ranges.

**electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)**

| PARAMETER              |                | TEST CONDITIONS                                                                                                  |                                  | MIN                  | TYP <sup>‡</sup> | MAX | UNIT |    |
|------------------------|----------------|------------------------------------------------------------------------------------------------------------------|----------------------------------|----------------------|------------------|-----|------|----|
| $V_{IK}$               | Data inputs    | $V_{CC} = 3\text{ V}$                                                                                            | $I_I = 18\text{ mA}$             | 3.6                  | $V_{CC}-1.2$     |     | V    |    |
|                        |                |                                                                                                                  | $I_I = -18\text{ mA}$            | -0.9                 | -1.2             |     |      |    |
| $I_I$                  | Control inputs | $V_{CC} = 3.6\text{ V}$ ,                                                                                        | $V_I = V_{CC}$ or GND            |                      |                  | ±10 | μA   |    |
|                        | Data inputs    | $V_{CC} = 3.6\text{ V}$                                                                                          | $V_I = V_{CC}$                   | $\overline{OE}$ low  | 0.4              | 0.6 | mA   |    |
|                        |                |                                                                                                                  |                                  | $\overline{OE}$ high |                  |     | 25   | μA |
|                        |                |                                                                                                                  | $V_I = 0$                        | $\overline{OE}$ low  | -0.8             | -1  | mA   |    |
| $\overline{OE}$ high   |                |                                                                                                                  |                                  | -60                  | μA               |     |      |    |
| $I_{OZH}$              |                | $V_{CC} = 3.6\text{ V}$ ,                                                                                        | $V_O = 3\text{ V}$               | 0.6                  |                  | 20  | μA   |    |
| $I_{OZL}$              |                | $V_{CC} = 3.6\text{ V}$ ,                                                                                        | $V_O = 0.5\text{ V}$             | -0.1                 |                  | -50 | μA   |    |
| $I_{CC}/\text{buffer}$ |                | $V_{CC} = 3.6\text{ V}$ ,                                                                                        | $I_O = 0$ ,                      |                      |                  | 3.7 | 5.6  | mA |
| $I_{CCZ}$              |                | $V_{CC} = 3.6\text{ V}$ ,                                                                                        | Control inputs = $V_{CC}$ or GND |                      |                  |     | 0.8  | mA |
| $\Delta I_{CC}^{\S}$   |                | $V_{CC} = 3\text{ V}$ to $3.6\text{ V}$ , One input at $V_{CC} - 0.6\text{ V}$ , Other inputs at $V_{CC}$ or GND |                                  |                      |                  |     | 600  | μA |
| $C_i$                  |                | $V_I = 3\text{ V}$ or 0                                                                                          |                                  |                      |                  | 4.5 |      | pF |
| $C_o$                  |                | $V_O = 3\text{ V}$ or 0                                                                                          |                                  |                      |                  | 5.5 |      | pF |

<sup>‡</sup> All typical values are at  $V_{CC} = 3.3\text{ V}$ ,  $T_A = 25^\circ\text{C}$ .

<sup>§</sup> This is the increase in supply current for each input that is at the specified TTL voltage level rather than  $V_{CC}$  or GND.

**switching characteristics over recommended operating free-air temperature range,  $C_L = 50\text{ pF}$  (unless otherwise noted) (see Figure 3)**

| PARAMETER | FROM (INPUT)    | TO (OUTPUT) | $V_{CC} = 3.3\text{ V} \pm 0.3\text{ V}$ |                  |     | UNIT |
|-----------|-----------------|-------------|------------------------------------------|------------------|-----|------|
|           |                 |             | MIN                                      | TYP <sup>‡</sup> | MAX |      |
| $t_{pd}$  | A               | Y           | 0.6                                      | 1.3              | 2   | ns   |
| $t_{en}$  | $\overline{OE}$ | Y           | 1.3                                      | 2.5              | 4.7 | ns   |
| $t_{dis}$ | $\overline{OE}$ | Y           | 1.8                                      | 2.8              | 4.2 | ns   |

<sup>‡</sup> All typical values are at  $V_{CC} = 3.3\text{ V}$ ,  $T_A = 25^\circ\text{C}$ .



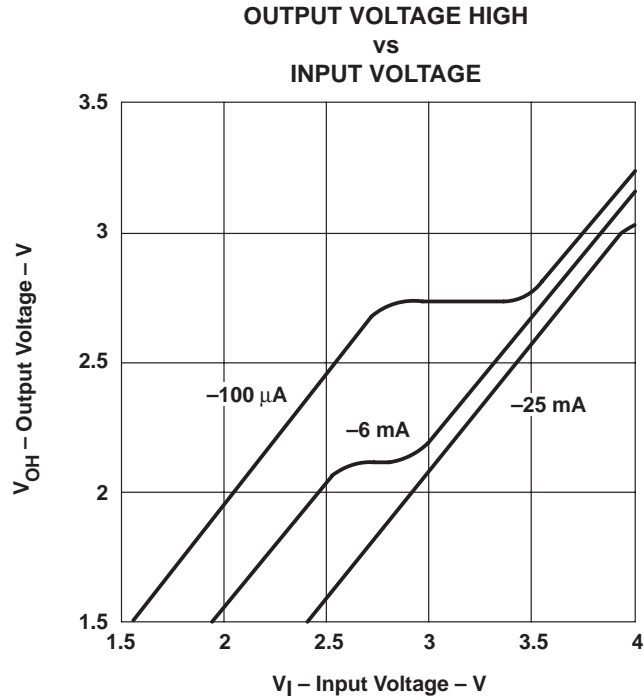


Figure 1.  $V_{OH}$  Over Recommended Free-Air Temperature Range

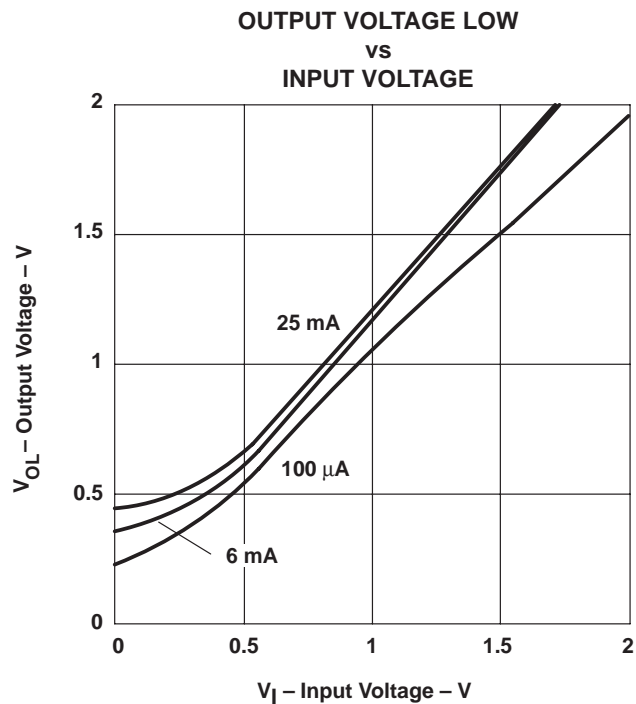
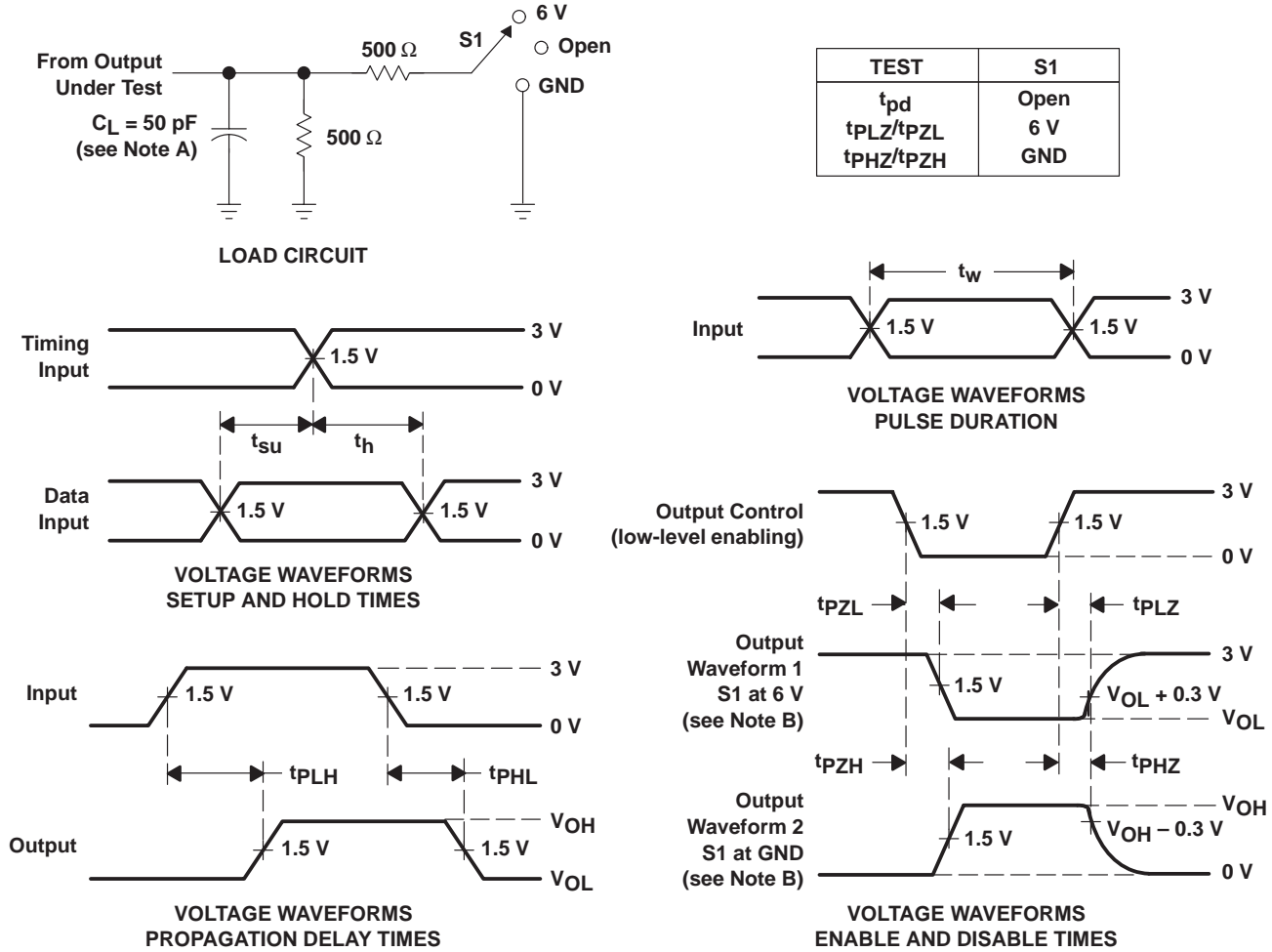


Figure 2.  $V_{OL}$  Over Recommended Free-Air Temperature Range

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**PARAMETER MEASUREMENT INFORMATION**



- NOTES:
- A.  $C_L$  includes probe and jig capacitance.
  - B. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.
  - C. All input pulses are supplied by generators having the following characteristics:  $PRR \leq 10 \text{ MHz}$ ,  $Z_O = 50 \Omega$ ,  $t_r \leq 2.5 \text{ ns}$ ,  $t_f \leq 2.5 \text{ ns}$ .
  - D. The outputs are measured one at a time with one transition per measurement.
  - E.  $t_{PLZ}$  and  $t_{PHZ}$  are the same as  $t_{dis}$ .
  - F.  $t_{PZL}$  and  $t_{PZH}$  are the same as  $t_{en}$ .
  - G.  $t_{PLH}$  and  $t_{PHL}$  are the same as  $t_{pd}$ .

**Figure 3. Load Circuit and Voltage Waveforms**

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